

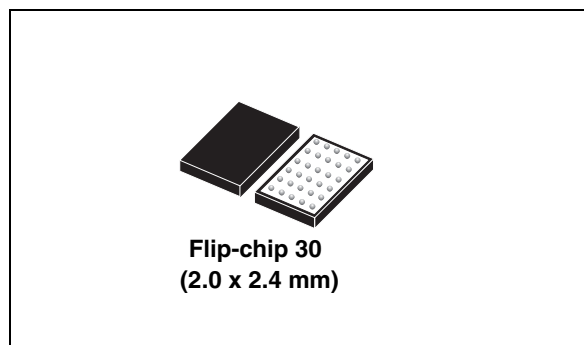


STG3820

Low voltage high bandwidth quad DPDT switch

Features

- Ultra low power dissipation:
 - $I_{CC} = 1 \mu\text{A}$ (max) at $T_A = 85 \text{ }^\circ\text{C}$
- Low "ON" resistance:
 - $R_{ON} = 5.4 \Omega$ ($T_A = 25 \text{ }^\circ\text{C}$) at $V_{CC} = 4.3 \text{ V}$
 - $R_{ON} = 6.6 \Omega$ ($T_A = 25 \text{ }^\circ\text{C}$) at $V_{CC} = 3.0 \text{ V}$
- Wide operating voltage range:
 - V_{CC} (OPR) = 1.65 V to 4.3 V
- 4.3 V tolerant and 1.8 V compatible threshold on digital control input at $V_{CC} = 2.3 \text{ V}$ to 3.0 V
- 4 select pins controlling 2 switches each
- Typical bandwidth (-3 dB) at 800 MHz on all channels
- USB (2.0) high speed (480 Mbps) signal switching compliant
- Integrated fail safe function
- Latch-up performance exceeds 100 mA per JESD 78, Class II
- ESD performance exceeds JESD22 2000-V human body model (A114-A)



Description

The STG3820 is a high-speed CMOS low voltage quad analog DPDT (dual pole dual throw) switch or 2:1 multiplexer/de-multiplexer switch fabricated in silicon gate C2MOS technology. It is designed to operate from 1.65 V to 4.3 V, making this device ideal for portable applications.

The SELm-n input is provided to control the switches. The switches nS1 and mS1 are ON (connected to common ports Dn and Dm respectively) when the SELm-n input is held high and OFF (high impedance state exists between the two ports) when SELm-n is held low. The switches nS2 and mS2 are ON (connected to common port Dn and Dm respectively) when the SELm-n input is held low and OFF (high impedance state exists between the two ports) when SELm-n is held high.

The STG3820 has an integrated fail safe function to withstand over-voltage condition when the device is powered off. Additional key features are fast switching speed, break-before-make-delay time and ultra low power consumption. All inputs and outputs are equipped with protection circuits against static discharge, giving them ESD immunity and transient excess voltage.

Applications

- Mobile phones

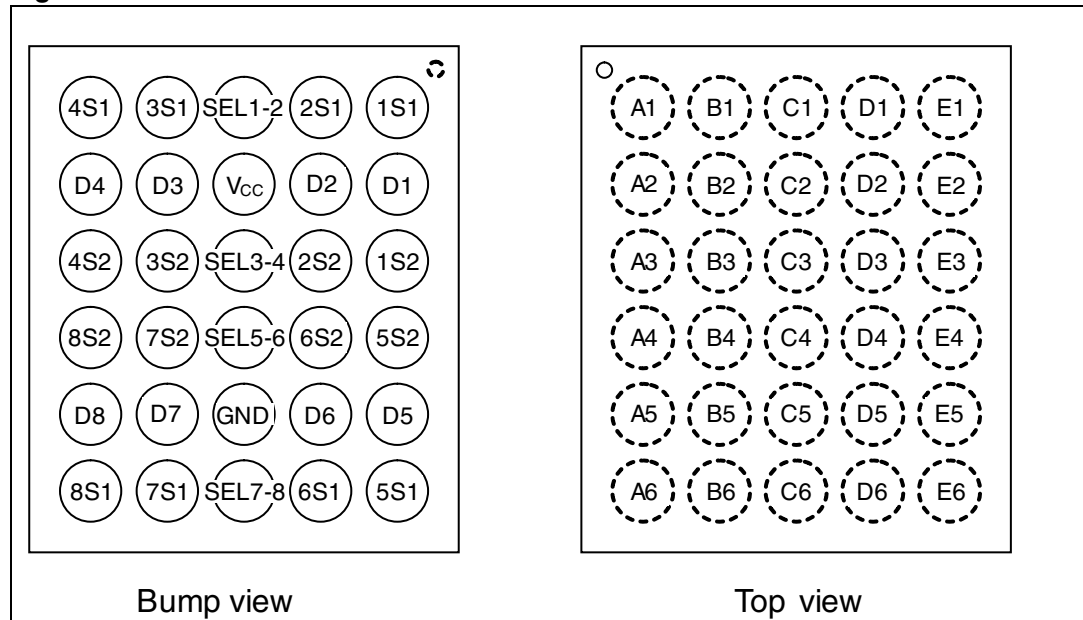
Table 1. Device summary

Order code	Package	Packaging
STG3820BJR	Flip-chip 30 (2.0 x 2.4 mm)	Tape & reel

1 Pin settings

1.1 Pin connection

Figure 1. Pin connection



1.2 Pin description

Table 2. Pin assignment

Pin Number	Symbol	Name and function
A1	1S1	Independent channel for switch 1
A2	D1	Common channel for switch 1
A3	1S2	Independent channel for switch 1
A4	5S2	Independent channel for switch 5
A5	D5	Common channel for switch 5
A6	5S1	Independent channel for switch 5
B1	2S1	Independent channel for switch 2
B2	D2	Common channel for switch 2
B3	2S2	Independent channel for switch 2
B4	6S2	Independent channel for switch 6
B5	D6	Common channel for switch 6
B6	6S1	Independent channel for switch 6
C1	SEL1-2	Switch 1-2 selection control

Table 2. Pin assignment (continued)

Pin Number	Symbol	Name and function
C2	VCC	Positive supply voltage
C3	SEL3-4	Switch 3-4 selection control
C4	SEL5-6	Switch 5-6 selection control
C5	GND	Ground (0 V)
C6	SEL7-8	Switch 7-8 selection control
D1	3S1	Independent channel for switch 3
D2	D3	Common channel for switch 3
D3	3S2	Independent channel for switch 3
D4	7S2	Independent channel for switch 7
D5	D7	Common channel for switch 7
D6	7S1	Independent channel for switch 7
E1	4S1	Independent channel for switch 4
E2	D4	Common channel for switch 4
E3	4S2	Independent channel for switch 4
E4	8S2	Independent channel for switch 8
E5	D8	Common channel for switch 8
E6	8S1	Independent channel for switch 8

2 Logic diagram

Figure 2. Logic equivalent circuit

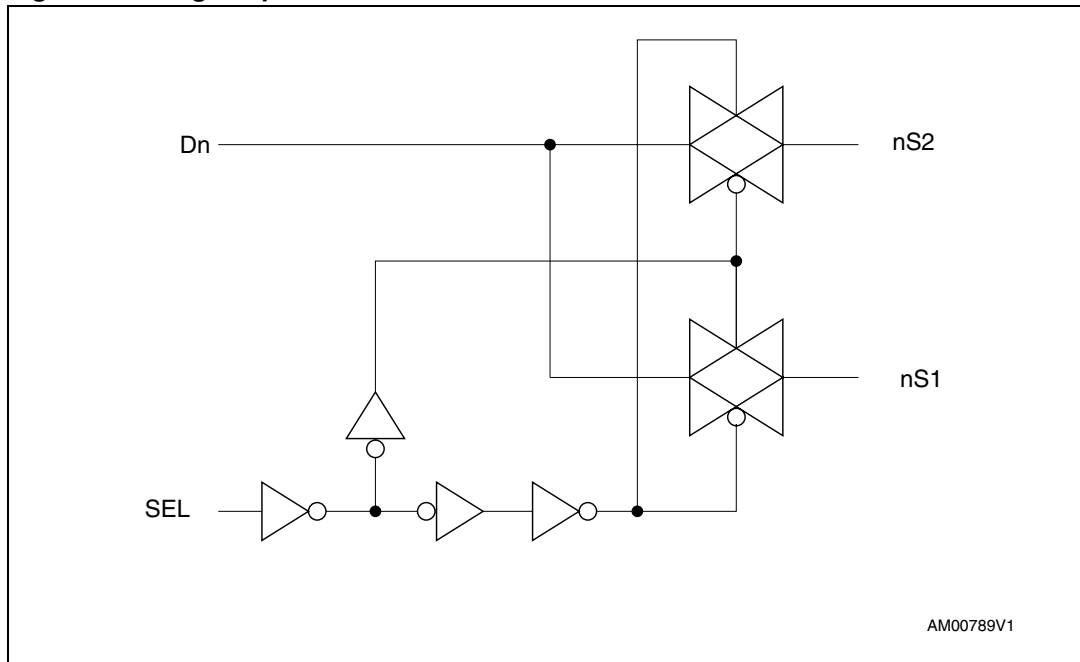


Table 3. Truth table

SEL	Switch nS1	Switch nS2
H	ON	OFF ⁽¹⁾
L	OFF ⁽¹⁾	ON

1. High impedance.

3 Maximum ratings

Stressing the device above the rating listed in the [Table 4](#) may cause permanent damage to the device. These are stress ratings only and operation of the device at these or any other conditions above those indicated in the operating sections of this specification is not implied. Exposure to absolute maximum ratings conditions for extended periods may affect device reliability.

Table 4. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{CC}	Supply voltage	-0.5 to 5.5	V
V_I	DC input voltage	-0.5 to $V_{CC} + 0.5$	V
V_{IC}	DC control input voltage	-0.5 to 5.5	V
V_O	DC output voltage	-0.5 to $V_{CC} + 0.5$	V
I_{IKC}	DC input diode current on control pin ($V_{SEL} < 0$ V)	-50	mA
I_{IK}	DC input diode current ($V_{SEL} < 0$ V)	± 50	mA
I_{OK}	DC output diode current	± 20	mA
I_O	DC output current	± 128	mA
I_{OP}	DC output current peak (pulse at 1ms, 10% duty cycle)	± 300	mA
I_{CC} or I_{GND}	DC V_{CC} or ground current	± 100	mA
P_D	Power dissipation at $T_A = 70$ °C	1120	mW
T_{stg}	Storage temperature	-65 to +150	°C
T_L	Lead temperature (10 sec)	300	°C

3.1 Recommended operating conditions

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Table 5. Recommended operating conditions

Symbol	Parameter	Value	Unit
V_{CC}	Supply voltage	1.65 to 4.3	V
V_I	Input voltage	0 to V_{CC}	V
V_{IC}	Control input voltage	0 to 4.3	V
V_O	Output voltage	0 to V_{CC}	V
T_{op}	Operating temperature	-40 to 85	°C
dt/dv	Input rise and fall time control input	$V_L = 1.65$ V to 2.7 V	0 to 20
		$V_L = 3.0$ V to 4.3 V	0 to 10

4 Electrical characteristics

Table 6. DC specifications

Symbol	Parameter	V _{CC} (V)	Test conditions	Value					Unit
				T _A = 25 °C			-40 to 85 °C		
				Min	Typ	Max	Min	Max	
V _{IH}	High level input voltage	1.65 – 1.95		0.65	–	–	0.65	–	V
		2.3 – 2.5		V _{CC}	–	–	0.65	–	
		2.7 – 3.0		1.2	–	–	1.2	–	
		3.3 – 3.6		1.3	–	–	1.3	–	
		4.3		1.4	–	–	1.4	–	
V _{IL}	Low level input voltage	1.65 – 1.95		–	–	0.25	–	0.25	V
		2.3 – 2.5		–	–	0.25	–	0.25	
		2.7 – 3.0		–	–	0.25	–	0.25	
		3.3 – 3.6		–	–	0.30	–	0.30	
		4.3		–	–	0.40	–	0.40	
R _{PEAK}	Switch ON peak resistance	1.8	V _S = 0 V to V _{CC} I _S = 8 mA	–	17.0	19.6	–	–	Ω
		2.7		–	7.5	8.7	–	–	
		3.0		–	6.6	7.6	–	–	
		3.7		–	5.8	6.7	–	–	
		4.3		–	5.4	6.2	–	–	
R _{ON}	Switch ON resistance	3.0	V _S = 3 V I _S = 8 mA	–	5.1	5.8	–	–	Ω
		3.0	V _S = 0.4 V I _S = 8 mA	–	6.3	7.3	–	–	
ΔR _{ON}	ON resistance match between channels ⁽¹⁾	1.8	V _S at R _{ON} MAX I _S = 8 mA	–	–	–	–	–	Ω
		2.7		–	–	–	–	–	
		3.0		–	0.3	–	–	–	
		3.7		–	–	–	–	–	
		4.3		–	–	–	–	–	

Table 6. DC specifications (continued)

Symbol	Parameter	V _{CC} (V)	Test conditions	Value					Unit
				T _A = 25 °C			-40 to 85 °C		
				Min	Typ	Max	Min	Max	
R _{FLAT}	ON resistance flatness ⁽²⁾	1.8	V _S = 0 V to 0.4 V I _S = 8 mA	–	4.5	–	–	–	Ω
		1.8	V _S = 0 V to V _{CC} I _S = 8 mA	–	9.5	–	–	–	
		2.7		–	2.2	–	–	–	
		3.0		–	1.8	–	–	–	
		3.7		–	1.6	–	–	–	
		4.3		–	1.6	–	–	–	
I _{OFF}	OFF state leakage current (Sn), (D)	4.3	V _S = 0.3 or 4 V	-20	–	20	-100	100	nA
I _{IN}	Input leakage current	0 to 4.3	V _{SEL} = 0 to 4.3 V	-0.2	–	0.2	-1.0	1.0	μA
I _{CC}	Quiescent supply current	1.65 to 4.3	V _{SEL} = V _{CC} or GND	-0.2	–	0.2	-1.0	1.0	μA
I _{CCLV}	Quiescent supply current for low voltage driving ⁽³⁾	4.3	V _{SEL} = 1.65 V	–	±37	±50	–	±100	μA
			V _{SEL} = 1.80 V	–	±33	±40	–	±50	
			V _{SEL} = 2.60 V	–	±11	±20	–	±30	

1. $\Delta R_{ON} = \max |mSN - nSN|$, where $m = 1$ to 8 and $n = 1$ to 8 , $N = 1, 2$.

2. Flatness is defined as the difference between the maximum and minimum value of on-resistance as measured over the specified analog signal ranges.

3. Measurement is for one SEL pin.

Electrical characteristics

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Table 7. AC electrical characteristics ($C_L = 35 \text{ pF}$, $R_L = 50 \text{ } \Omega$, $t_r = t_f \leq 5 \text{ ns}$)

Symbol	Parameter	V_{CC} (V)	Test conditions	Value					Unit
				$T_A = 25 \text{ } ^\circ\text{C}$			$-40 \text{ to } 85 \text{ } ^\circ\text{C}$		
				Min	Typ	Max	Min	Max	
t_{PLH} , t_{PHL}	Propagation delay	1.65 - 1.95		–	0.21	–	–	–	ns
		2.3 - 2.7		–	0.15	–	–		
		3.0 - 3.3		–	0.14	–	–		
		3.6 - 4.3		–	0.13	–	–		
t_{ON}	Turn on time	1.65 - 1.95	$V_S = 0.8 \text{ V}$	–	36	–	–	–	ns
		2.3 - 2.7	$V_S = 1.5 \text{ V}$	–	20	23	–	26	
		3.0 - 3.3		–	15	17	–	20	
		3.6 - 4.3		–	13	15	–	17	
t_{OFF}	Turn off time	1.65 - 1.95	$V_S = 0.8 \text{ V}$	–	29	–	–	–	ns
		2.3 - 2.7	$V_S = 1.5 \text{ V}$	–	19	22	–	25	
		3.0 - 3.3		–	14	16	–	18	
		3.6 - 4.3		–	11	13	–	14	
t_D	Break-before-make time delay	1.65 - 1.95	$C_L = 35 \text{ pF}$ $R_L = 50 \text{ } \Omega$ $V_S = 1.5 \text{ V}$	–	10	–	–	–	ns
		2.3 - 2.7		–	7	–	–		
		3.0 - 3.3		–	6	–	–		
		3.6 - 4.3		–	4	–	–		
Q	Charge injection	1.65	$C_L = 100 \text{ pF}$ $V_{GEN} = 0 \text{ V}$ $R_{GEN} = 0 \text{ } \Omega$	–	3.9	–	–	–	pC
		2.3		–	4.8	–	–		
		3.0		–	5.2	–	–		
		4.3		–	6.4	–	–		

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Table 8. AC electrical characteristics ($C_L = 5 \text{ pF}$, $R_L = 50 \text{ } \Omega$, $T_A = 25 \text{ } ^\circ\text{C}$)

Symbol	Parameter	V_{CC} (V)	Test conditions	Value					Unit
				$T_A = 25 \text{ } ^\circ\text{C}$			$-40 \text{ to } 85 \text{ } ^\circ\text{C}$		
				Min	Typ	Max	Min	Max	
OIRR	OFF isolation ⁽¹⁾	1.65 – 4.3	$V_S = 1 \text{ V}_{RMS}$, $f = 1 \text{ MHz}$ Signal = 0 dBm	–	-78	–	–	–	dB
			$V_S = 1 \text{ V}_{RMS}$, $f = 10 \text{ MHz}$ Signal = 0 dBm	–	-57	–	–	–	
Xtalk	Crosstalk	1.65 – 4.3	$V_S = 1 \text{ V}_{RMS}$, $f = 1 \text{ MHz}$ Signal = 0 dBm	–	-78	–	–	–	dB
			$V_S = 1 \text{ V}_{RMS}$, $f = 10 \text{ MHz}$ Signal = 0 dBm	–	-58	–	–	–	
BW	-3dB bandwidth	3.0 – 4.3	$R_L = 50 \text{ } \Omega$ Signal = 0 dBm	–	800	–	–	–	MHz
C_{IN}	Control pin input capacitance		$V_{CC} = 0 \text{ V}$	–	2	–	–	–	pF
C_{ON}	Sn Port capacitance when switch is enabled	3.3	$f = 240 \text{ MHz}$	–	6	–	–	–	
C_{OFF}	Sn Port capacitance when switch is disabled	3.3	$f = 240 \text{ MHz}$	–	2	–	–	–	

www.DataSheet4U.com 1. Off isolation = $20 \text{ Log}_{10} (V_D/V_S)$, V_D = output, V_S = input to off switch.

Electrical characteristics

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Table 9. USB related AC electrical characteristics

Symbol	Parameter	V _{CC} (V)	Test conditions	Value					Unit
				T _A = 25 °C			-40 to 85 °C		
				Min	Typ	Max	Min	Max	
t _{SK(0)}	Channel-to-channel skew	3.0 - 3.6	C _L = 10 pF	–	26	–	–	–	ps
t _{SK(P)}	Skew of opposite transition of the same output	3.0 - 3.6	C _L = 10 pF	–	60	–	–	–	ps
T _J	Total jitter	3.0 - 3.6	R _L = 50 Ω C _L = 10 pF t _R = t _F = 750 ps at 480 Mbps	–	130	–	–	–	ps

5 Test circuits

Figure 3. On-resistance

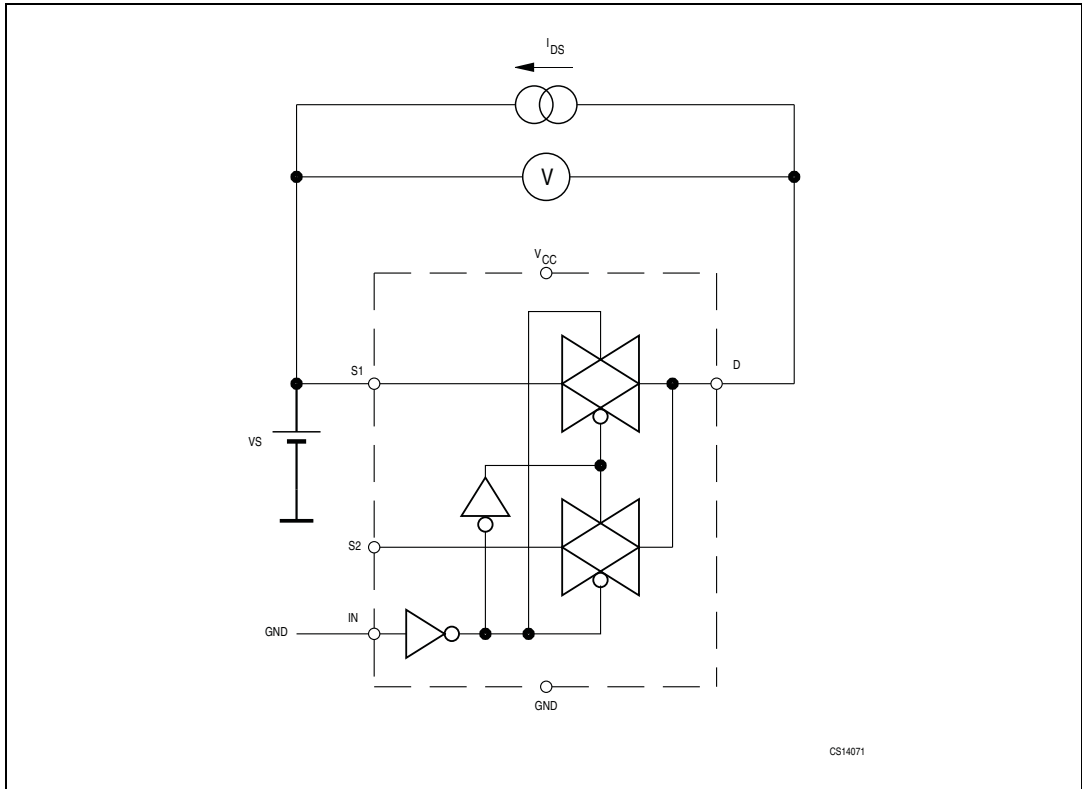
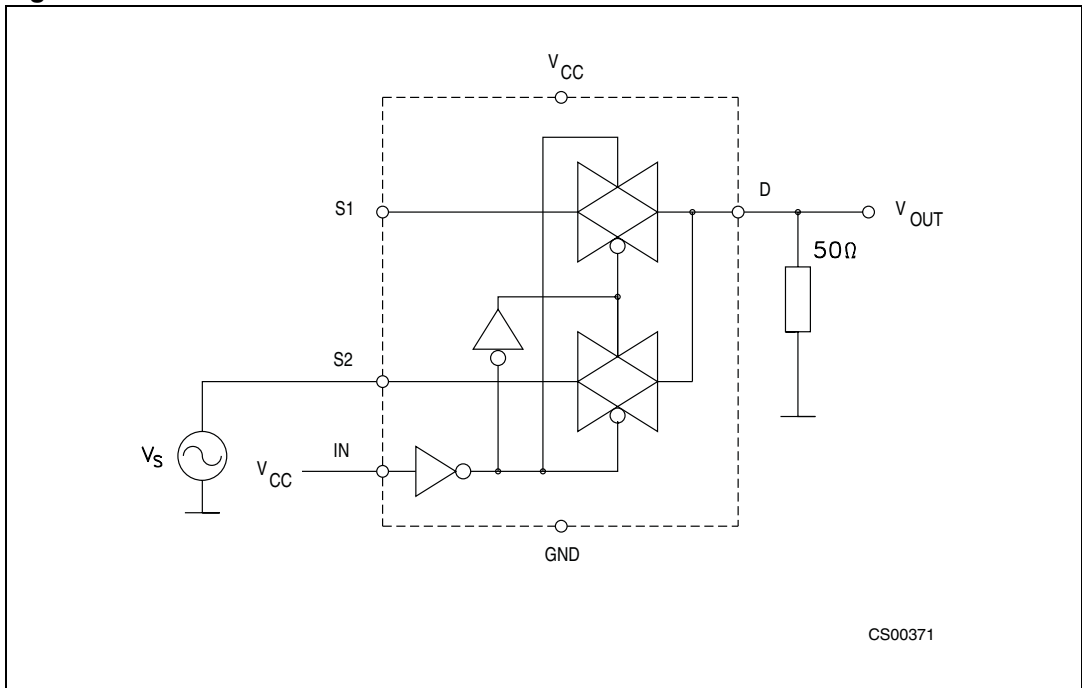


Figure 4. Bandwidth



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Figure 5. Off leakage

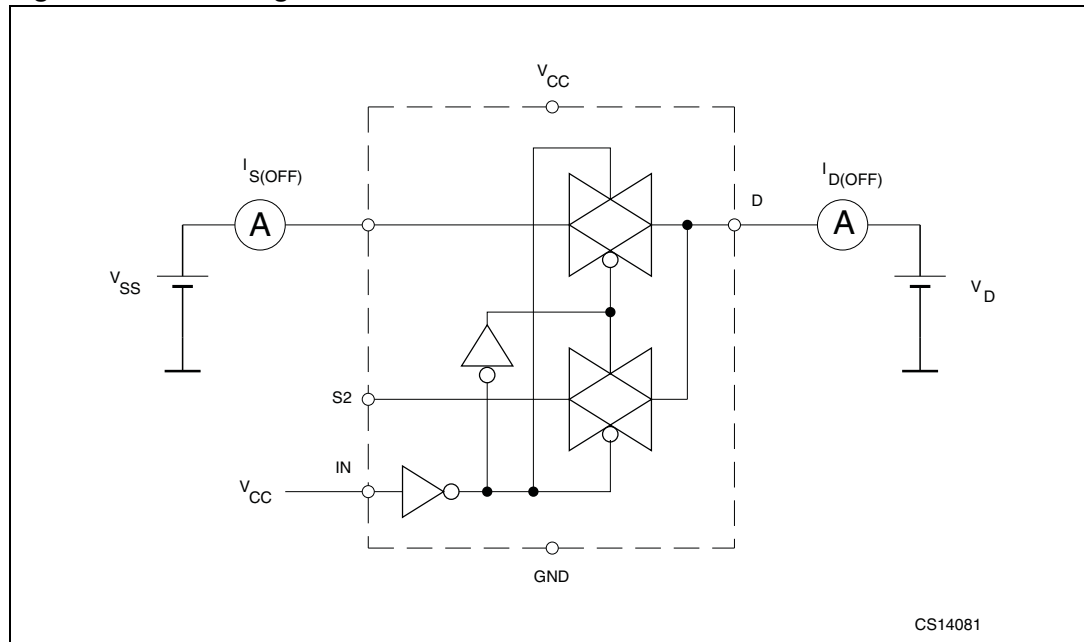
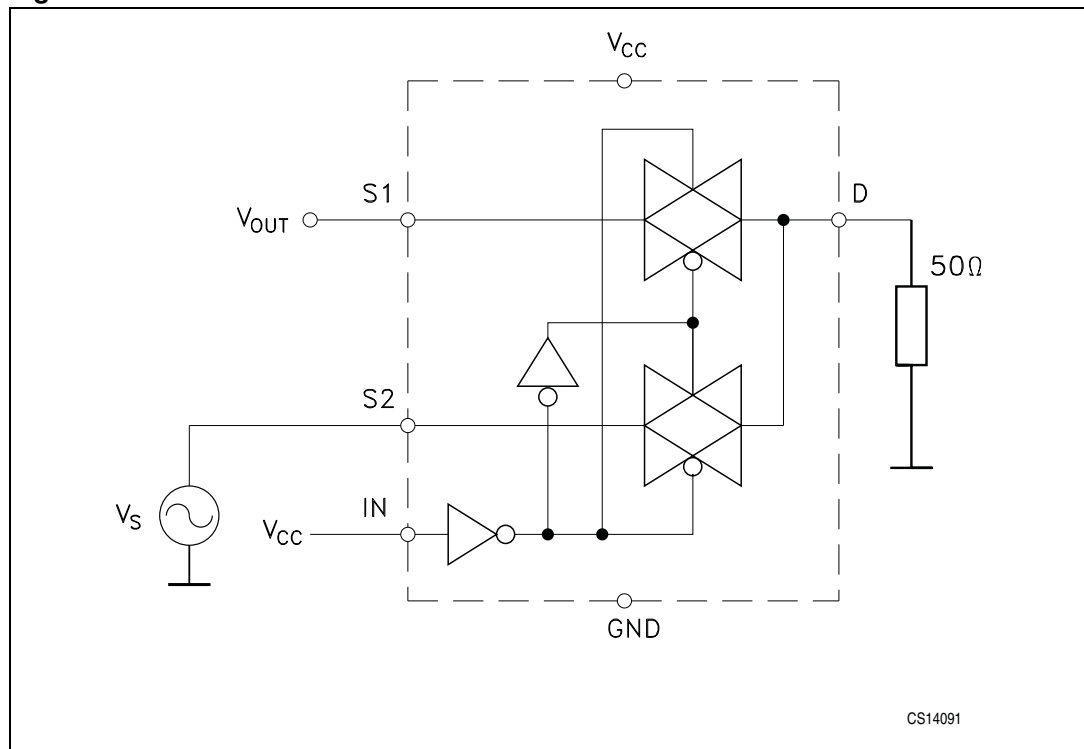


Figure 6. Channel to channel crosstalk



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Figure 7. Off isolation

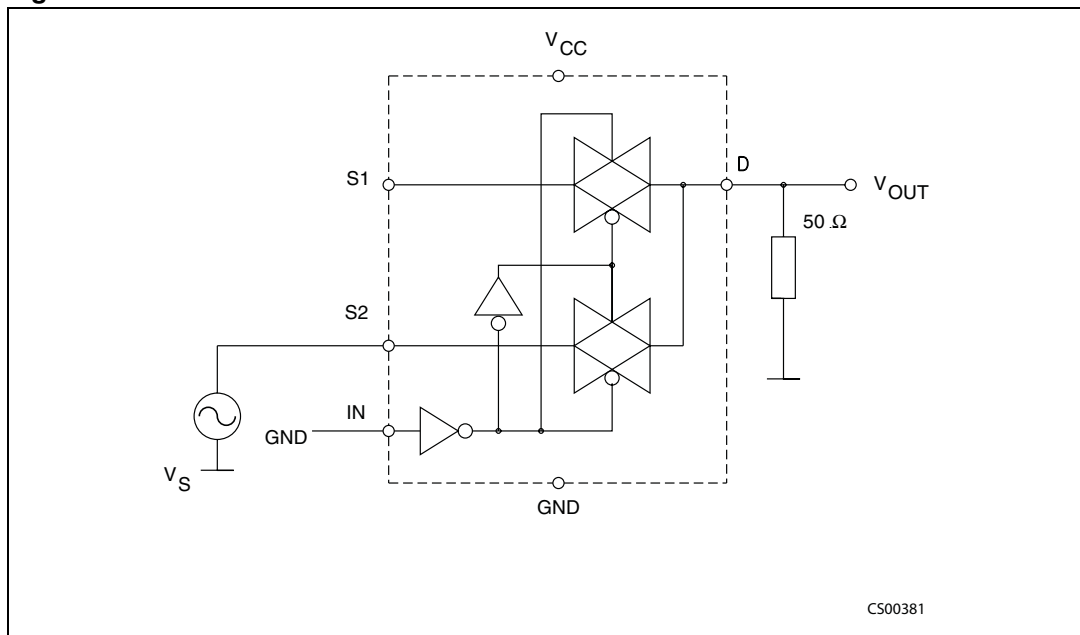
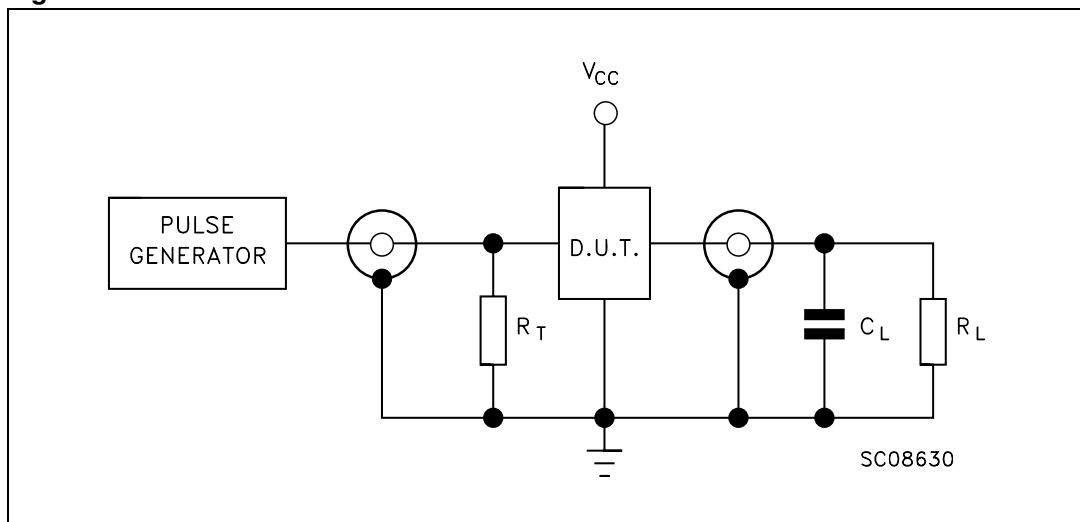


Figure 8. Test circuit



- Note:
- 1 $C_L = 5/35 \text{ pF}$ or equivalent: (includes jig capacitance)
 - 2 $R_L = 50 \Omega$ or equivalent
 - 3 $R_T = Z_{OUT}$ of pulse generator (typically 50Ω)

Figure 9. Break-before-make time delay

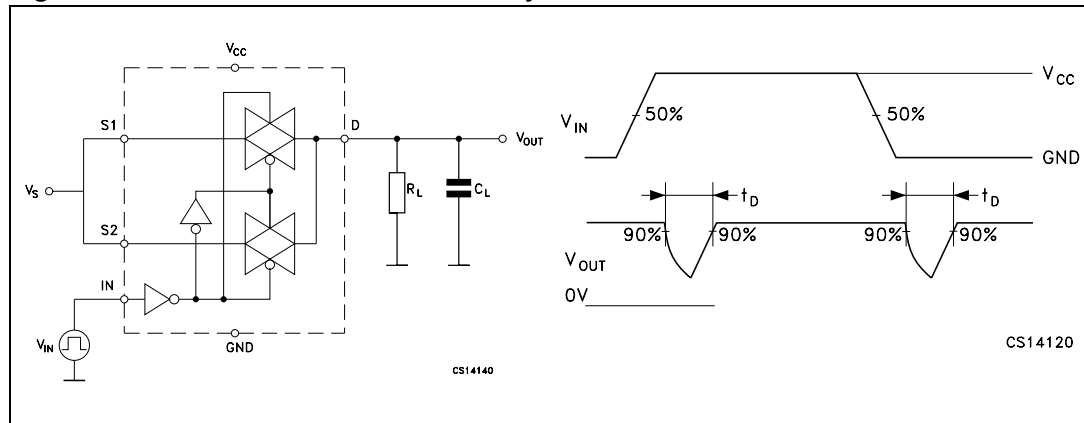


Figure 10. Switching time and charge injection ($V_{GEN} = 0\text{ V}$, $R_{GEN} = 0\ \Omega$, $R_L = 1\text{ M}\Omega$, $C_L = 100\text{ pF}$)

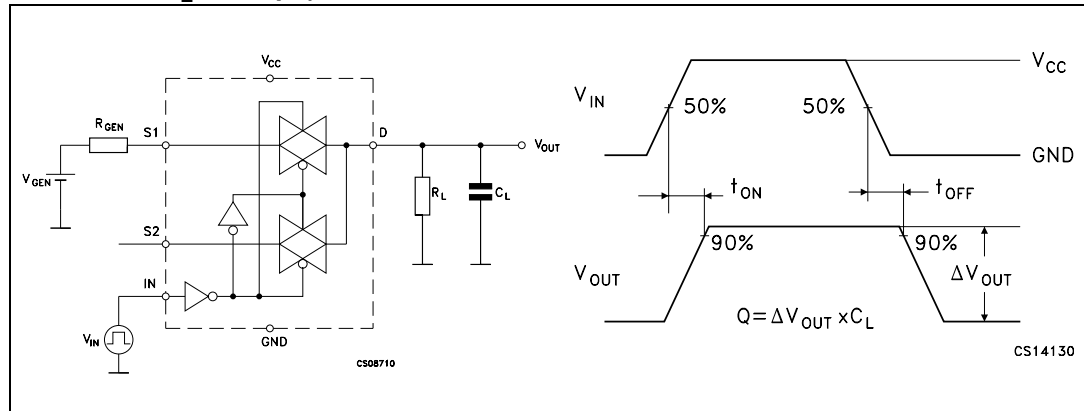
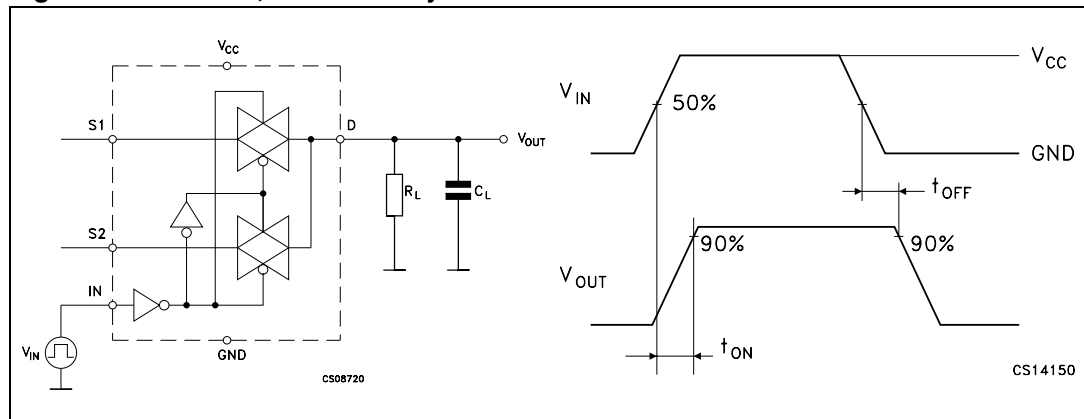


Figure 11. Turn on, turn off delay time



6 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

Figure 12. Package outline for Flip-chip 30 (2.0 x 2.4 x 0.625 mm) - 0.4 mm pitch

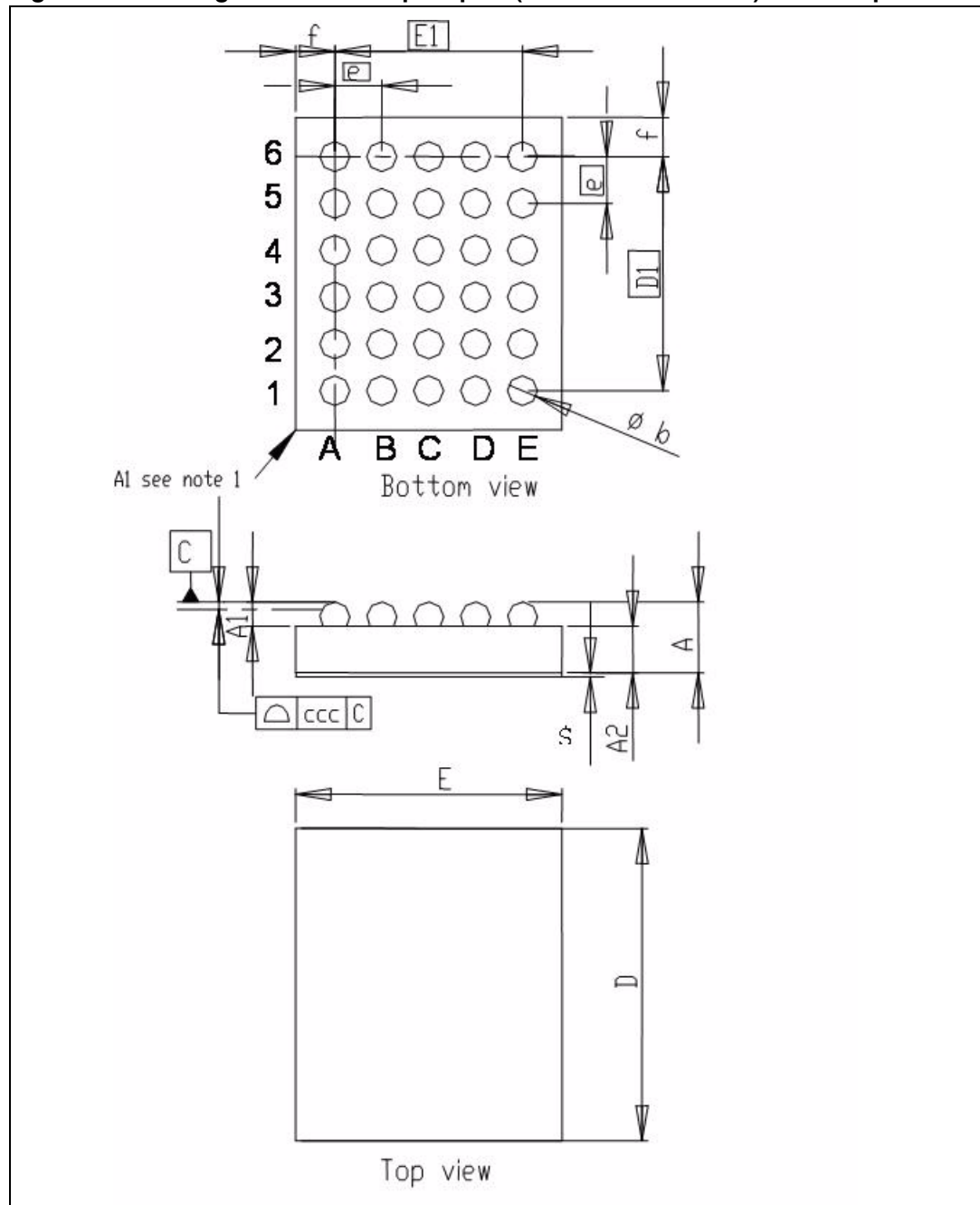


Table 10. Mechanical data for Flip-chip 30 (2.0 x 2.4 x 0.625 mm) - 0.4 mm pitch

Symbol	Millimeters		
	Min	Typ	Max
A	0.565	0.625	0.685
A1	0.17	0.205	0.24
A2	0.355	0.375	0.395
b	0.215	0.255	0.295
D	2.1	2.4	2.43
D1	–	2.0	–
E	1.97	2.0	2.03
E1	–	1.6	–
e	0.36	0.4	0.44
f	0.19	0.2	0.21
ccc	–	0.05	–
\$	0.040	0.045	0.05

Table 11. Footprint recommendations for Flip-chip 30 (2.0 x 2.4 x 0.625 mm) - 0.4 mm pitch

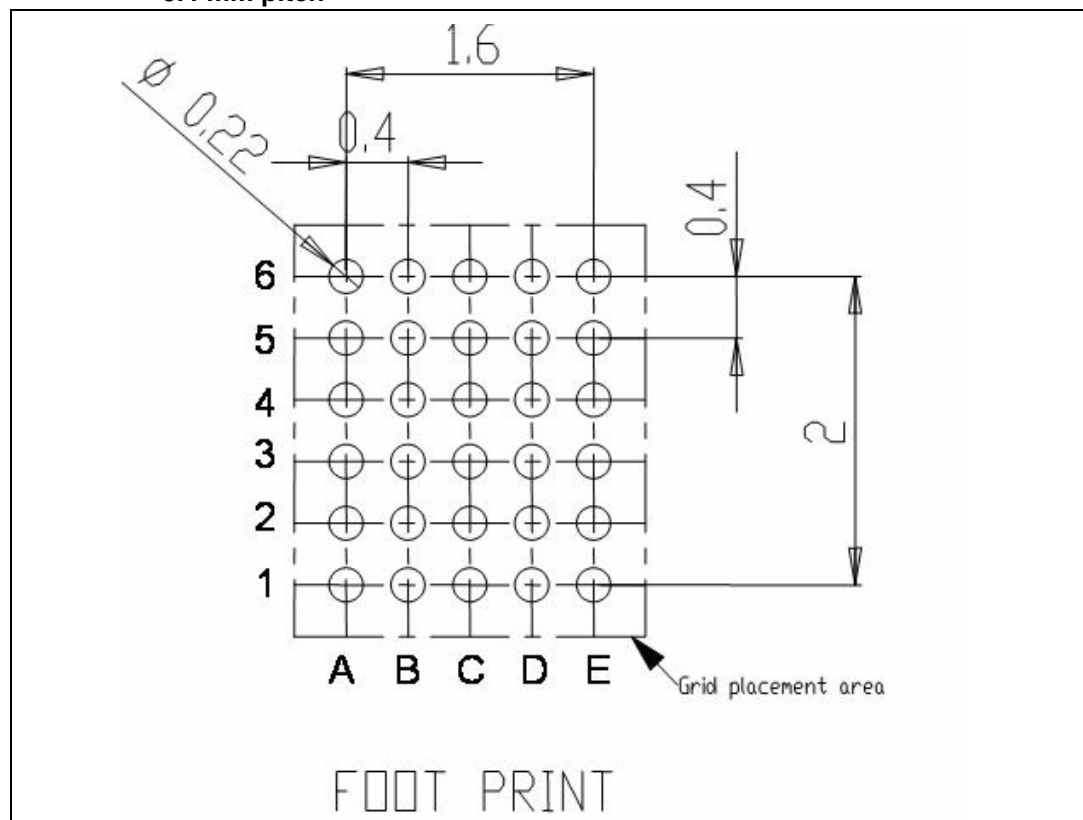


Figure 13. Tape information

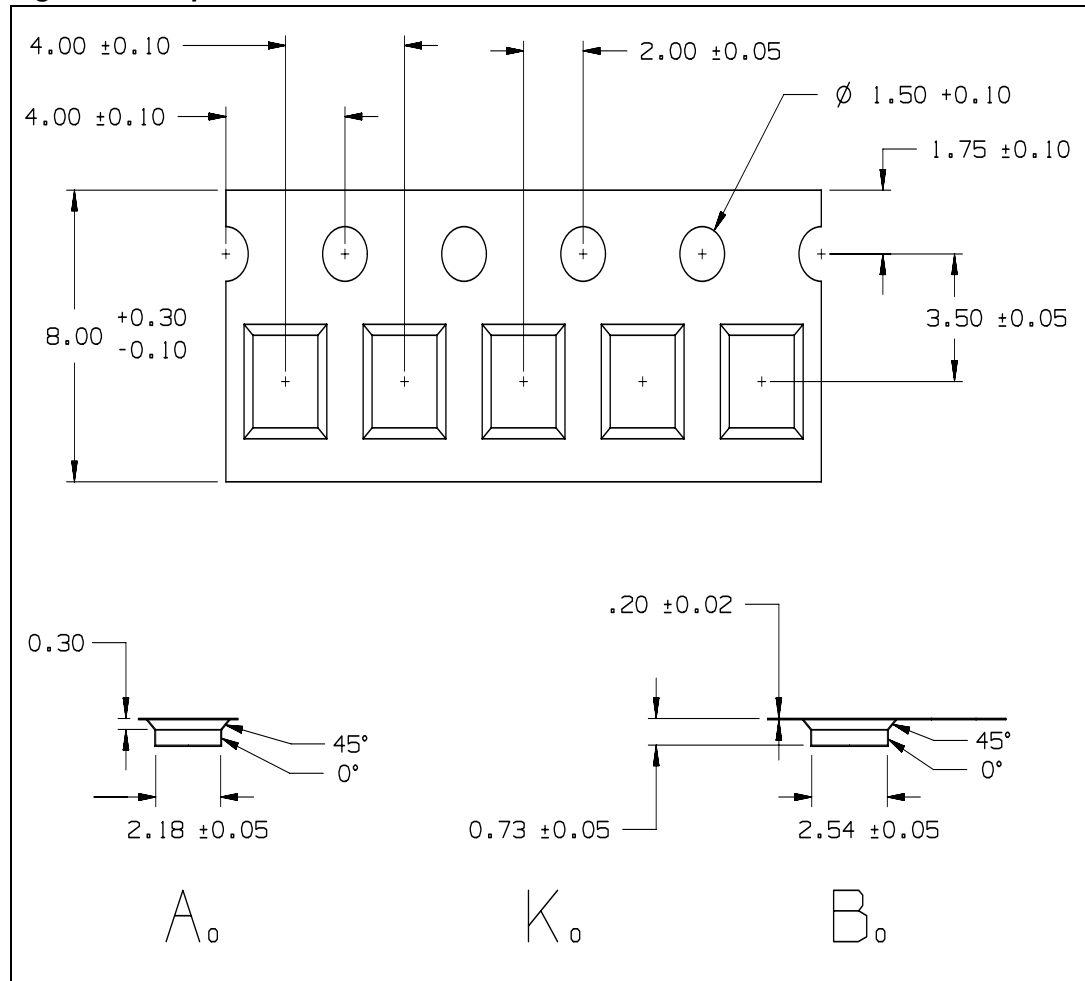
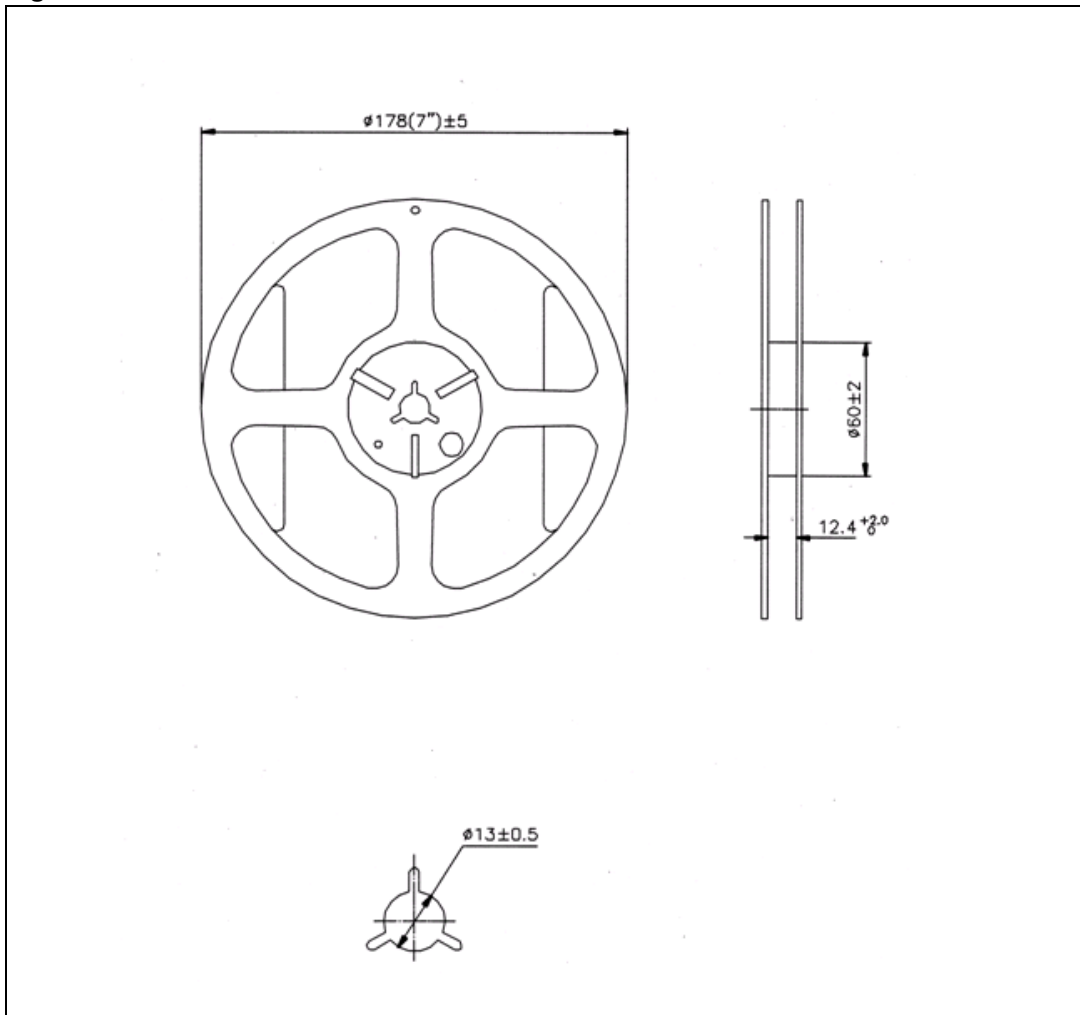


Figure 14. Reel information



7 Revision history

Table 12. Document revision history

Date	Revision	Changes
18-Dec-2009	1	Initial release.

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